

SN54LS646 THRU SN54LS649 SN74LS646 THRU SN74LS649 OCTAL BUS TRANSCEIVERS AND REGISTERS

D2661, DECEMBER 1982 — REVISED MARCH 1988

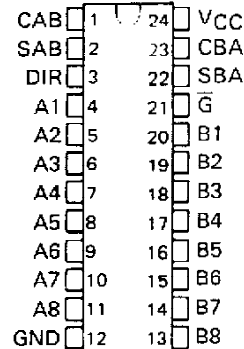
- Independent Registers for A and B Buses
- Multiplexed Real-Time and Stored Data
- Choice of True or Inverting Data Paths
- Choice of 3-State or Open-Collector Outputs
- Included Among the Package Options Are Compact 24-pin 300-mil-Wide Plastic and Ceramic DIPs, Ceramic Chip Carriers, and Plastic "Small Outline" Packages
- Dependable Texas Instruments Quality and Reliability

DEVICE	OUTPUT	LOGIC
'LS646	3-State	True
'LS647	Open-Collector	True
'LS648	3-State	Inverting
'LS649	Open-Collector	Inverting

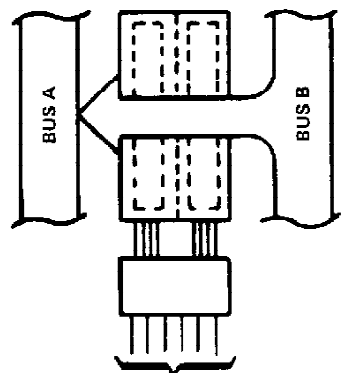
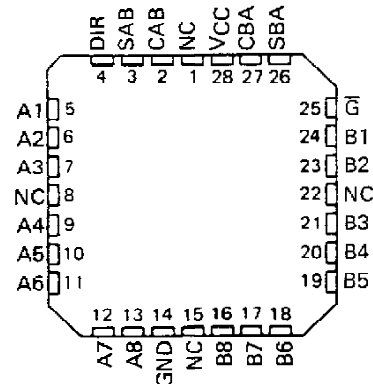
description

These devices consist of bus transceiver circuits with 3-state or open-collector outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus will be clocked into the registers on the low-to-high transition of the appropriate clock pin (CAB or CBA). The following examples demonstrate the four fundamental bus-management functions that can be performed with the octal bus transceivers and registers.

SN54LS'...JT PACKAGE
SN74LS'...DW OR NT PACKAGE
(TOP VIEW)

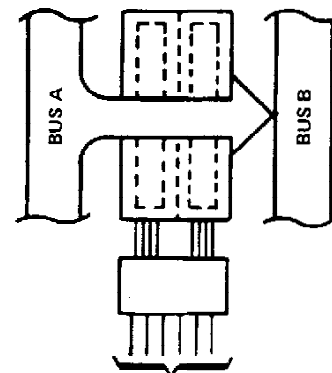


SN54LS'...FK PACKAGE
(TOP VIEW)



(21)	(3)	(1)	(23)	(2)	(22)
\bar{G}	DIR	CAB	CBA	SAB	SBA
L	L	X	H or L	X	L

REAL-TIME TRANSFER
BUS B TO BUS A



(21)	(3)	(1)	(23)	(2)	(22)
\bar{G}	DIR	CAB	CBA	SAB	SBA
L	H	H or L	X	L	X

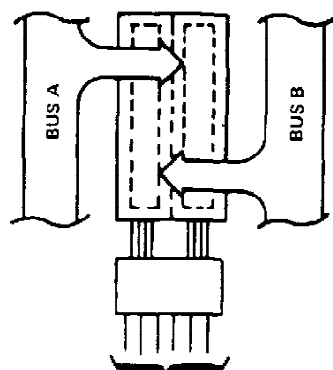
REAL-TIME TRANSFER
BUS A TO BUS B

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

TEXAS
INSTRUMENTS

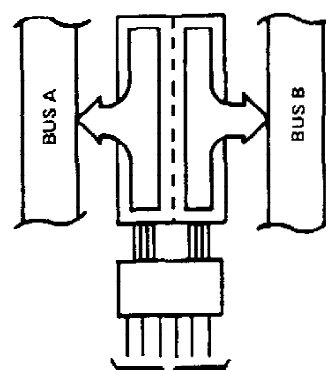
POST OFFICE BOX 655072 • DALLAS, TEXAS 75265

SN54LS646 THRU SN54LS649, SN74LS646 THRU SN74LS649 OCTAL BUS TRANSCEIVERS AND REGISTERS



(21)	(3)	(1)	(23)	(2)	(22)
\overline{G}	DIR	CAB	CBA	SAB	SBA
X	X	↑	X	X	X
X	X	X	↑	X	X
H	X	↑	↑	X	X

STORAGE FROM
A, B, OR A AND B



(21)	(3)	(1)	(23)	(2)	(22)
\overline{G}	DIR	CAB	CBA	SAB	SBA
L	L	X	X	X	H
L	H	X	X	H	X

TRANSFER
STORED DATA
TO A OR B

Enable (\overline{G}) and direction (DIR) pins are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port may be stored in either register or in both. The select controls (SAB and SBA) can multiplex stored and real-time (transparent mode) data. The direction control determines which bus will receive data when enable \overline{G} is active (low). In the isolation mode (control \overline{G} high), A data may be stored in one register and/or B data may be stored in the other register.

When an output function is disabled, the input function is still enabled and may be used to store and transmit data. Only one of the two buses, A or B, may be driven at a time.

The SN54' family is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74' family is characterized for operation from 0° to 70°C .

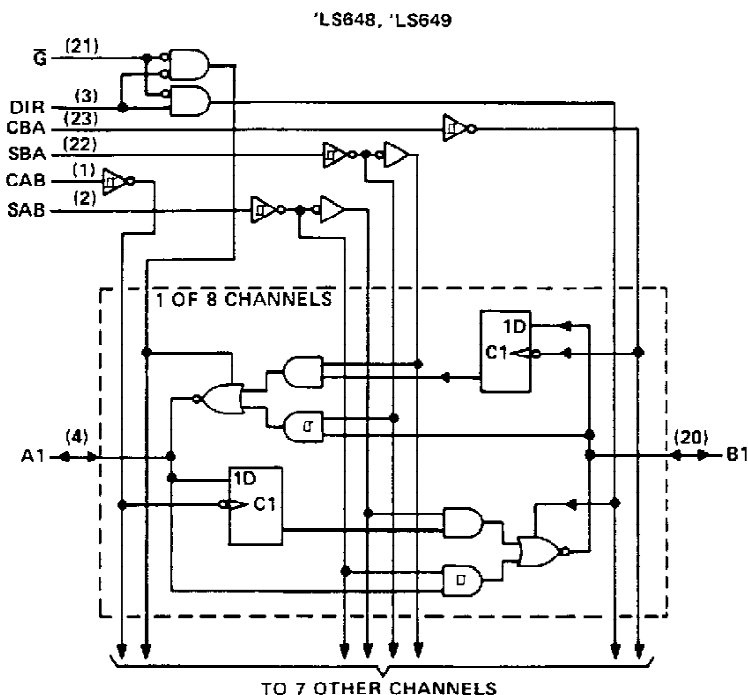
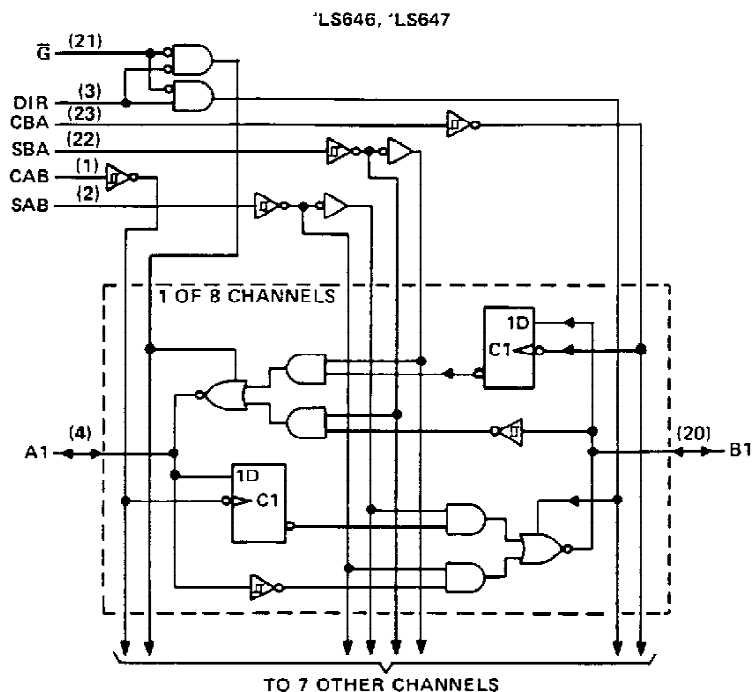
FUNCTION TABLE

INPUTS						DATA I/O†		OPERATION OR FUNCTION	
\overline{G}	DIR	CAB	CBA	SAB	SBA	A1 THRU A8	B1 THRU B8	LS646, LS647	LS648, LS649
X	X	↑	X	X	X	Input	Not specified	Store A, B unspecified	Store A, B unspecified
X	X	X	↑	X	X	Not specified	Input	Store B, A unspecified	Store B, A unspecified
H	X	↑	↑	X	X	Input	Input	Store A and B Data	Store A and B Data
H	X	H or L	H or L	X	X	Input	Input	Isolation, hold storage	Isolation, hold storage
L	L	X	H or L	X	L	Output	Input	Real-Time B Data to A Bus	Real-Time \overline{B} Data to A Bus
L	L	X	X	X	H	Output	Input	Stored B Data to A Bus	Stored \overline{B} Data to A Bus
L	H	H or L	X	L	X	Input	Output	Real-Time A Data to B Bus	Real-Time \overline{A} Data to B Bus
L	H	X	X	H	X	Input	Output	Stored A Data to B Bus	Stored \overline{A} Data to B Bus

† The data output functions may be enabled or disabled by various signals at the \overline{G} and DIR inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every low-to-high transition on the clock inputs.

SN54LS646 THRU SN54LS649, SN74LS646 THRU SN74LS649 OCTAL BUS TRANSCEIVERS AND REGISTERS

logic diagrams (positive logic)



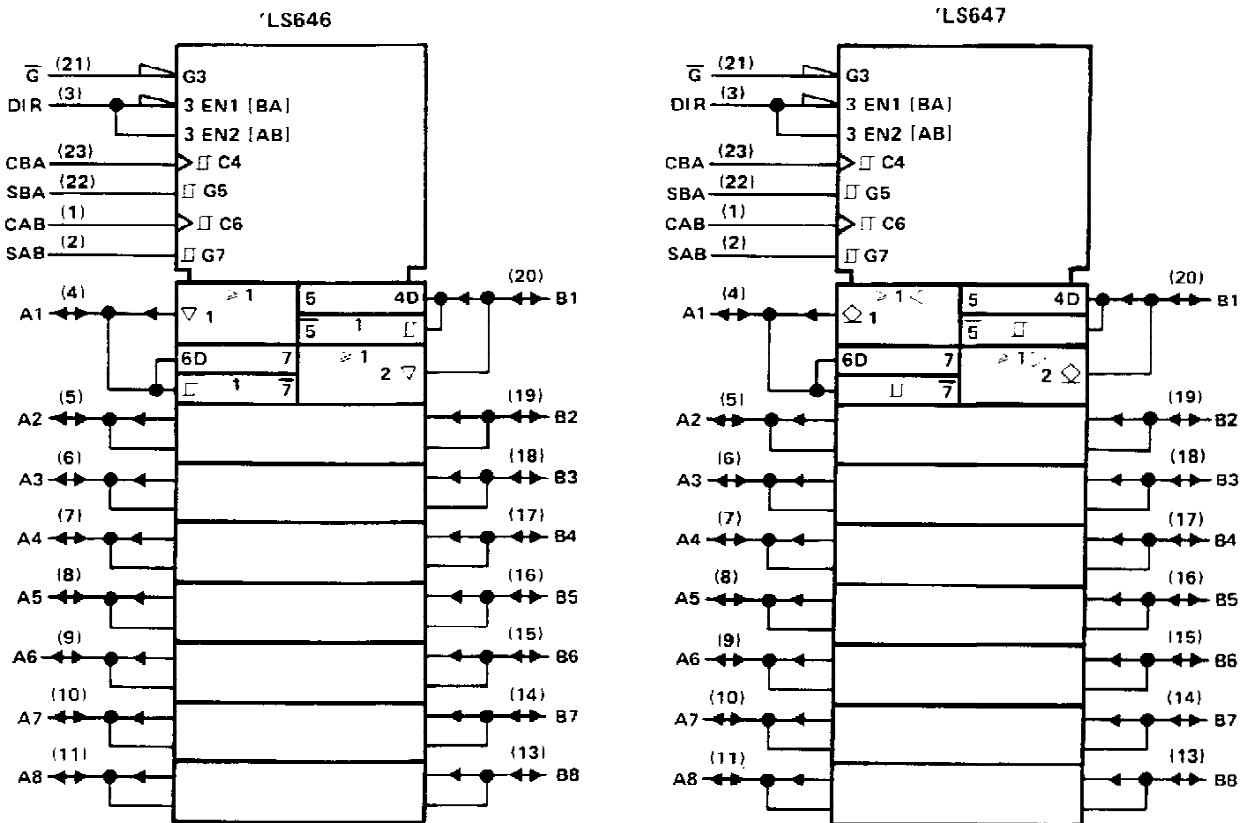
Pin numbers shown are for DW, JT, and NT packages.

TEXAS
INSTRUMENTS

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

SN54LS646, SN54LS647, SN74LS646, SN74LS647 **OCTAL BUS TRANSCEIVERS AND REGISTERS**

logic symbols†



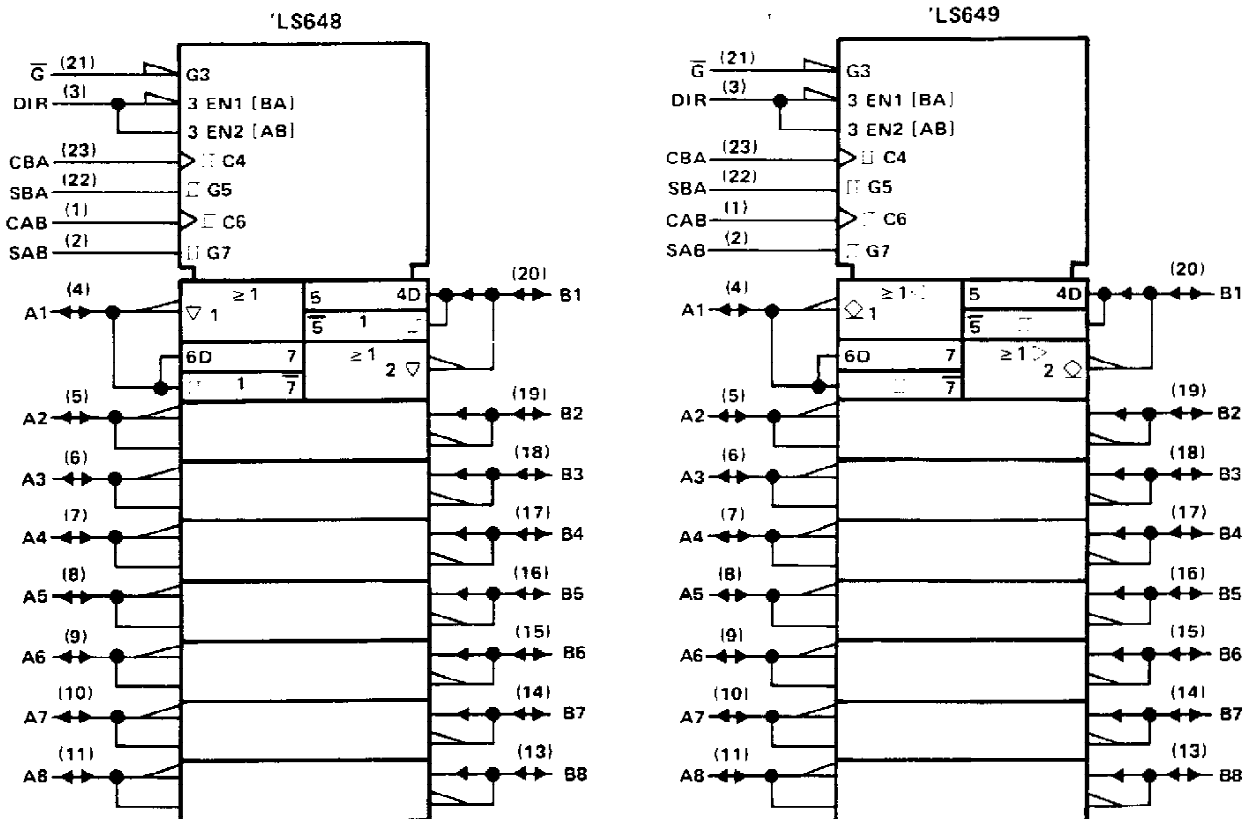
†These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.
 Pin numbers shown are for DW, JT, and NT packages.

TEXAS
INSTRUMENTS

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

SN54LS648, SN54LS649, SN74LS648, SN74LS649 OCTAL BUS TRANSCEIVERS AND REGISTERS

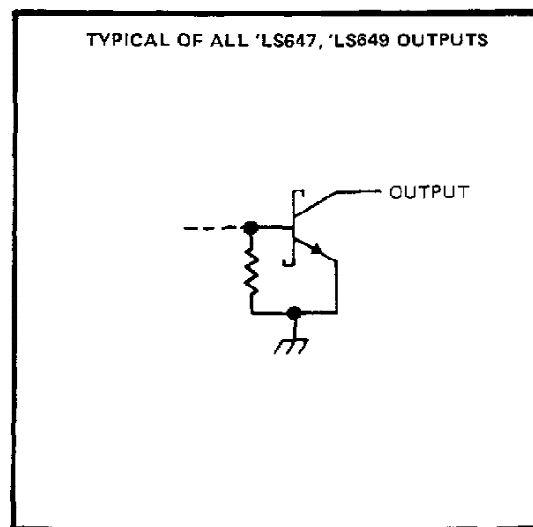
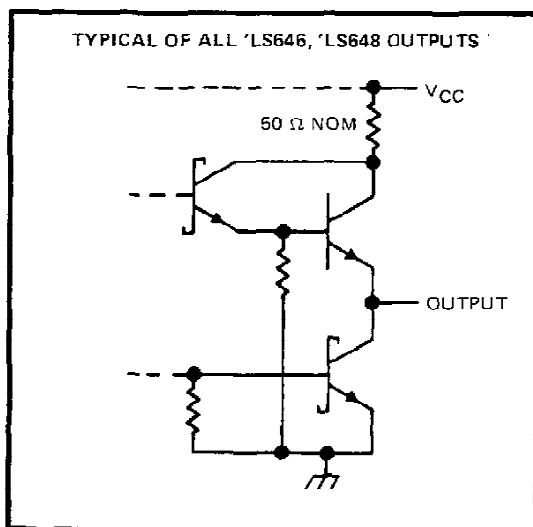
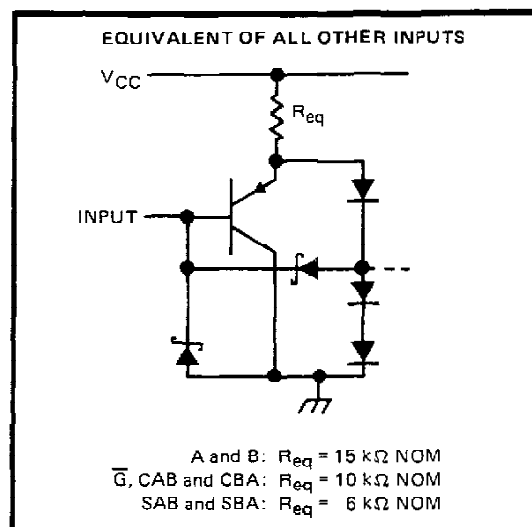
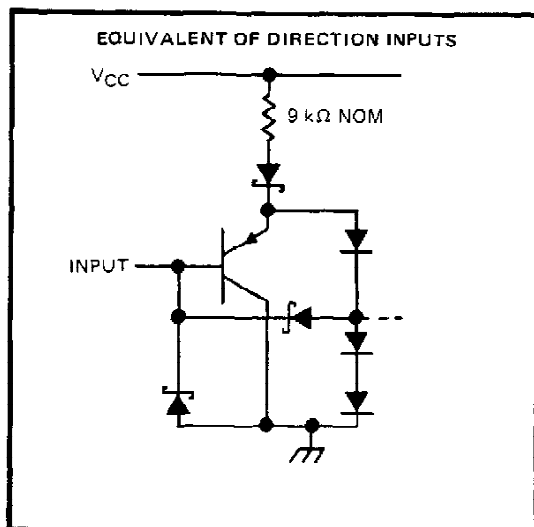
logic symbols[†] (continued)



[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.
Pin numbers shown are for DW, JT, and NT packages.

**SN54LS646 THRU SN54LS649,
SN74LS646 THRU SN74LS649
OCTAL BUS TRANSCEIVERS AND REGISTERS**

schematics of inputs and outputs



**TEXAS
INSTRUMENTS**

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

SN54LS646, SN54LS648, SN74LS646, SN74LS648

OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC}	7 V
Input voltage: Control inputs	7 V
I/O ports	5.5 V
Operating free-air temperature range: SN54LS646, SN54LS648	– 55°C to 125°C
SN74LS646, SN74LS648	0°C to 70°C
Storage temperature range	– 65°C to 150°C

recommended operating conditions

			SN54LS646/648			SN74LS646/648			UNIT		
			MIN	NOM	MAX	MIN	NOM	MAX			
V _{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V		
V _{IH}	High-level input voltage		2			2			V		
V _{IL}	Low-level input voltage				0.5			0.6	V		
I _{OH}	High-level output current				− 12			− 15	mA		
I _{OL}	Low-level output current				12			24	mA		
t _w	Pulse duration	CBA or CAB high	15			15			ns		
		CBA or CAB low	30			30					
		Data high or low	30			30					
t _{su}	Setup time before CAB† or CBA †	A or B	15			15			ns		
t _h	Hold time after CAB† or CBA †	A or B	0			0			ns		
T _A	Operating free-air temperature		− 55			125			0	70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN54LS646/648		SN74LS646/648		UNIT		
			MIN	TYP‡ MAX	MIN	TYP‡ MAX			
V _{IK}		V _{CC} = MIN, I _I = – 18 mA	– 1.5		– 1.5		V		
Hysteresis (V _{T+} – V _{T–})	A or B input	V _{CC} = MIN	0.1	0.4	0.2	0.4	V		
V _{OH}		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX	I _{OH} = – 3 mA		2.4	3.4	V		
			I _{OH} = – 12 mA		2				
			I _{OH} = – 15 mA		2				
V _{OL}		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX	I _{OL} = 12 mA		0.25	0.4	V		
			I _{OL} = 24 mA		0.35 0.5				
I _I	Control inputs	V _{CC} = MAX, V _I = 7 V	0.1		0.1		mA		
	A or B ports	V _{CC} = MAX, V _I = 5.5 V	0.1		0.1				
I _{IH}	Control inputs	V _{CC} = MAX, V _I = 2.7 V	20		20		µA		
	A or B ports‡		20		20				
I _{IL}	Control inputs	V _{CC} = MAX, V _I = 0.4 V	– 0.4		– 0.4		mA		
	A or B ports‡		– 0.4		– 0.4				
I _{OS} §		V _{CC} = MAX, V _O = 0 V	– 40	– 225	– 40	– 225	mA		
I _{CC}	LS646	V _{CC} = MAX	Outputs high		91	145	mA		
			Outputs low		103	165		103	165
			Outputs disabled		103	165		103	165
	LS648		Outputs high		91	145		91	145
			Outputs low		103	165		103	165
			Outputs disabled		120	180		120	180

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

¶ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.



POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

SN54LS646, SN54LS648, SN74LS646, SN74LS648
OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS646		'LS648		UNIT
				MIN	TYP	MAX	MIN	
t _{PLH}	CAB or CBA	A or B	R _L = 667 Ω, C _L = 45 pF, See Note 2	15	25	15	25	ns
t _{PHL}				23	35	24	40	ns
t _{PLH}	A or B	B or A		12	18	12	18	ns
t _{PHL}				13	20	15	25	ns
t _{PLH}	SAB or SBA [†] with Bus input high	A or B		26	40	37	55	ns
t _{PHL}				21	35	24	40	ns
t _{PLH}	SAB or SBA [†] with Bus input low	A or B		33	50	26	40	ns
t _{PHL}				14	25	23	40	ns
t _{PZH}	G	A or B	33	55	30	50	ns	
t _{PZL}			42	65	37	55	ns	
t _{PZH}	DIR	A or B	28	45	23	40	ns	
t _{PZL}			39	60	30	45	ns	
t _{PHZ}	G	A or B	23	35	28	45	ns	
t _{PLZ}			22	35	22	35	ns	
t _{PHZ}	DIR	A or B	20	30	24	35	ns	
t _{PLZ}			19	30	19	30	ns	

[†] These parameters are measured with the internal output state of the storage register opposite to that of the input.

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

SN54LS647, SN54LS649, SN74LS647, SN74LS649

OCTAL BUS TRANSCEIVERS AND REGISTERS WITH OPEN-COLLECTOR OUTPUTS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage (control inputs)	7 V
Off-state output voltage (A and B ports)	5.5 V
Operating free-air temperature range: SN54LS647, SN54LS649	– 55°C to 125°C
SN74LS647, SN74LS649	– 0°C to 70°C
Storage temperature range	– 65°C to 150°C

recommended operating conditions

		SN54LS647 SN54LS649			SN74LS647 SN74LS649			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.5			0.6	V
V _{OH}	High-level output voltage			5.5			5.5	V
I _{OL}	Low-level output voltage			12			24	mA
t _w	Pulse duration	CBA or CAB high			15			ns
		CBA or CAB low			30			
		Data high or low			30			
t _{su}	Setup time before CAB ↑ or CBA ↑	A or B			15			ns
t _h	Hold time after CAB↑ or CBA ↑	A or B			0			ns
T _A	Operating free-air temperature	− 55			125			°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN54LS647 SN54LS649		SN74LS647 SN74LS649		UNIT	
			MIN	TYP‡ MAX	MIN	TYP‡ MAX		
V _{IK}		V _{CC} = MIN, I _I = − 18 mA	− 1.5		− 1.5		V	
Hysteresis (V _{T+} − V _{T−})	A or B input	V _{CC} = MIN	0.1	0.4	0.2	0.4	V	
I _{OH}		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX, V _{OH} = 5.5 V	0.1		0.1		mA	
V _{OL}		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX I _{OL} = 12 mA I _{OL} = 24 mA	0.25 0.4		0.25 0.4 0.35 0.5		V	
I _I	A or B	V _{CC} = MAX	V _I = 5.5 V		0.1		mA	
	All others		V _I = 7 V		0.1			
I _{IH}		V _{CC} = MAX, V _I = 2.7 V		20		20	μA	
I _{IL}		V _{CC} = MAX, V _I = 0.4 V		− 0.4		− 0.4		mA
I _{CC}	'LS647	V _{CC} = MAX, Outputs open	Outputs high	79 130	79 130		mA	
			Outputs low	94 150	94 150			
	'LS649	V _{CC} = MAX, Outputs open	Outputs high	79 130	79 130			
			Outputs low	94 150	94 150			

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

TEXAS
INSTRUMENTS

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

SN54LS647, SN54LS649, SN74LS647, SN74LS649
OCTAL BUS TRANSCEIVERS AND REGISTERS WITH OPEN-COLLECTOR OUTPUTS

switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS647		'LS649		UNIT
				MIN	TYP	MAX	MIN	
t _{PLH}	CAB or CBA	A or B	R _L = 667 Ω, C _L = 45 pF, See Note 2	22	35	17	30	ns
t _{PHL}				28	45	28	45	ns
t _{PLH}	A or B	B or A		17	26	15	25	ns
t _{PHL}				18	27	20	30	ns
t _{PLH}	SAB or SBA† with Bus input high	A or B		33	50	37	55	ns
t _{PHL}				29	45	28	45	ns
t _{PLH}	SAB or SBA† with Bus input low			39	60	30	45	ns
t _{PHL}				19	30	26	40	ns
t _{PLH}	G	A or B		25	40	21	40	ns
t _{PHL}				33	50	34	50	ns
t _{PLH}	DIR			23	35	19	30	ns
t _{PHL}				25	40	27	45	ns

† These parameters are measured with the internal outputs state of the storage register opposite to that of the bus input.

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.